

10/585215

## (12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization  
International Bureau(43) International Publication Date  
20 October 2005 (20.10.2005)

PCT

(10) International Publication Number  
WO 2005/096731 A3

(51) International Patent Classification<sup>7</sup>: H05B 7/20

(21) International Application Number: PCT/US2005/010550

(22) International Filing Date: 29 March 2005 (29.03.2005)

(25) Filing Language: English

(26) Publication Language: English

(30) Priority Data: 60/557,889 30 March 2004 (30.03.2004) US

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(81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SM, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW.

(84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IS, IT, LT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

Declaration under Rule 4.17:  
— of inventorship (Rule 4.17(iv)) for US only

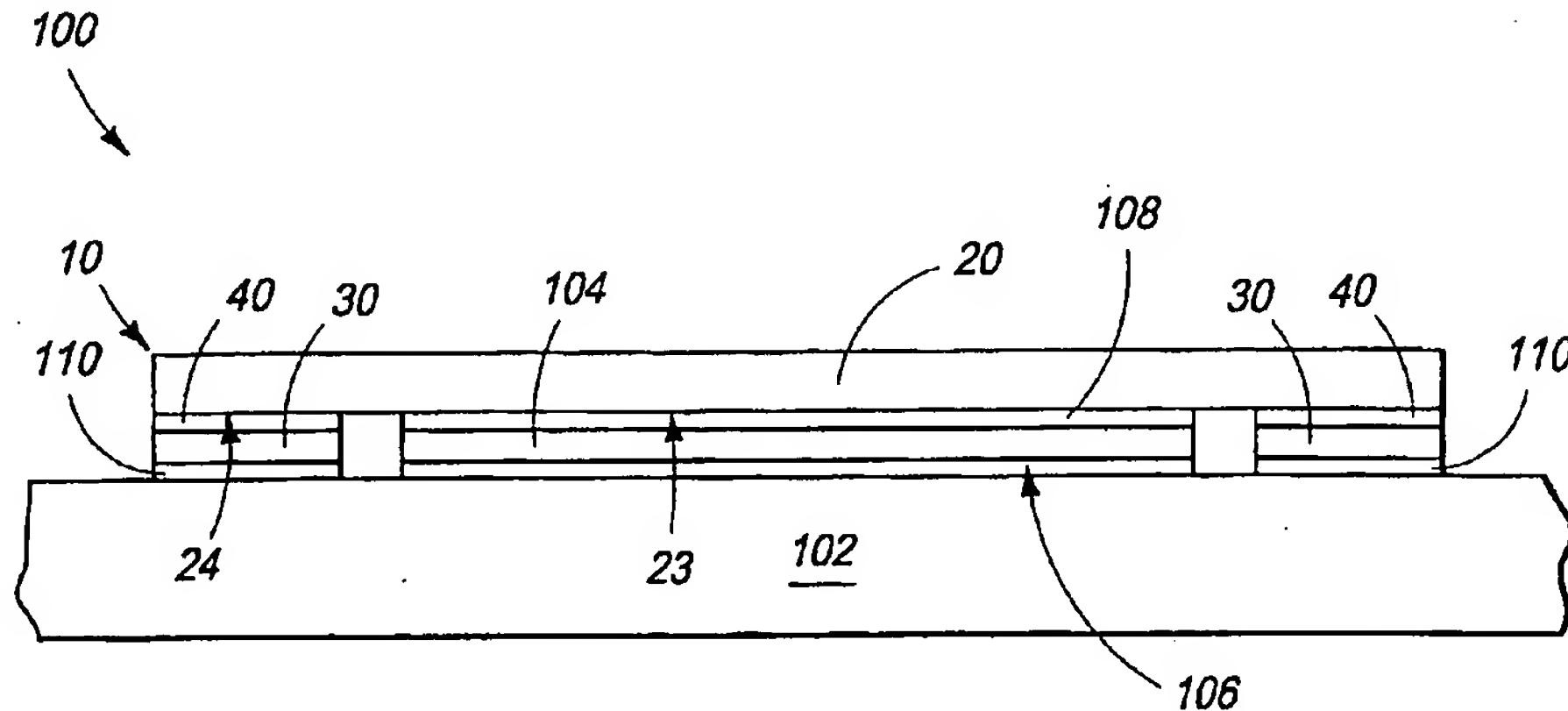
Published:  
— with international search report  
— before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments

(88) Date of publication of the international search report: 23 February 2006

{Continued on next page}

(54) Title: HEAT SPREADER CONSTRUCTIONS, INTEGRATED CIRCUITRY, METHODS OF FORMING HEAT SPREADER CONSTRUCTIONS, AND METHODS OF FORMING INTEGRATED CIRCUITRY

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(57) Abstract: The invention includes a heat spreader (10) having a base (20) which has a perimeter surface surrounding a heat-receiving region. A frame portion (30) interfaces the perimeter surface and has an opening traversing a thickness of the frame (30). The invention includes a method of forming a heat spreader construction by forming a base portion (20) having a perimeter region surrounding a heat-receiving surface. An independent frame portion (30) is joined to the base portion (20). The invention includes integrated circuitry (104) having a heat spreader construction (10) in thermal communication with a heat-generating device (104). The heat spreader (10) has a base (20) having a heat-receiving surface and a perimeter surface which interfaces a frame portion (30). The invention includes methodology for forming integrated circuitry which includes providing an integrated circuitry board (102) having a heat generating device (104) mounted thereon, and providing a multi-part heat spreader (10) in thermal communication with the heat-generating device (104).



*For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.*